

Title: INTEGRATED CIRCUITS USING OPTICAL FIBER INTERCONNECTS FORMED THROUGH A SEMICONDUCTOR WAFER
AND METHODS FOR FORMING SAME

Double Patenting Rejection

Claims 39-46, 48-53, 55-60, and 62-71 were rejected under the judicially created doctrine of double patenting over claims 1-22 of U.S. Patent No. 6,150,188. A Terminal Disclaimer in compliance with 37 CFR 1.321(b)(iv) is enclosed herewith to overcome these rejections.

Allowable Subject Matter

Claims 47, 54, 61, and 72 were objected to as being dependent upon a rejected base claim, but were indicated to be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. In view of the enclosed Terminal Disclaimer, claims 47, 54, 61, and 72 will no longer be dependent on a rejected a base claim. Applicant requests withdrawal of this objection.

CONCLUSION

Applicant respectfully submits that claims 39-72 are in condition for allowance and notification to that effect is earnestly requested. The Examiner is invited to telephone Applicant's attorney at (612) 373-6913 to facilitate prosecution of this application.

If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

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By their Representatives,

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Date Nov. 13, 2001

By

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this 13th day of November, 2001.

Name

Amy Morarty

Signature

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